

101043,561

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 6,770,565 B2
DATED : August 3, 2004
INVENTOR(S) : Olgado et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 5,

Line 58, change "wafers" to -- wafer, --

Column 13,

Line 15, delete "field thickness".

Line 33, change "move slowly then" to -- more slowly than --.

Column 14,

Line 8, insert a comma after the first occurrence of "containing materials".

Signed and Sealed this

Twenty-first Day of December, 2004



JON W. DUDAS
Director of the United States Patent and Trademark Office